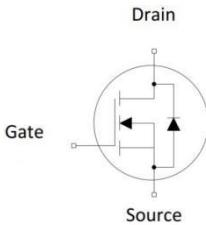


## N-channel 650V, 7A, 0.65Ω Super-Junction Power MOSFET

Description	Product Summary
<p>Super-junction power MOSFET is a revolutionary technology for high voltage power MOSFET , designed according to the SJ principle. The resulting device has extremely low on resistance,making it especially suitable for applications which require superior power density and outstanding efficiency.</p>	$V_{DS} @ T_{j,25^\circ C}$ 650V $R_{DS(on),max}$ 0.65Ω $I_D$ 7.0A $Q_{g,typ}$ 13.3 nC
<b>Features</b>	 <b>TO-252</b>  <b>TO-251</b>  <b>TO-220F</b>
<b>Applications</b>	  <b>N-Channel MOSFET</b>

### Marking information

Product	Package	Marking	Packing method
HMS7N65K	TO-252	HMS7N65K	Reel
HMS7N65I	TO-251	HMS7N65I	Tube
HMS7N65F	TO-220F	HMS7N65F	Tube

### Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DSS}$	650	V
Continuous drain current ( $T_c = 25^\circ C$ ) ( $T_c = 100^\circ C$ )	$I_D$	7 4.4	A A
Pulsed drain current <sup>1)</sup>	$I_{DM}$	21	A
Gate-Source voltage	$V_{GSS}$	$\pm 30$	V
Avalanche energy, single pulse <sup>2)</sup>	$E_{AS}$	120	mJ
Avalanche current, repetitive <sup>3)</sup>	$I_{AR}$	1.2	A
Power Dissipation TO-252 /TO-251 ( $T_c = 25^\circ C$ ) - Derate above $25^\circ C$	$P_D$	63 0.5	W W/ $^\circ C$
Power Dissipation TO-220F ( $T_c = 25^\circ C$ ) - Derate above $25^\circ C$	$P_D$	32 0.26	W W/ $^\circ C$
Operating and Storage Temperature Range	$T_J, T_{STG}$	-55 to +150	$^\circ C$
Continuous diode forward current	$I_S$	7	A

Diode pulse current	I <sub>S,pulse</sub>	21	A
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### Thermal Characteristics

Parameter	Symbol	Value		Unit
		TO252/TO-251	TO-220F	
Thermal Resistance, Junction-to-Case	R <sub>θJC</sub>	2	4	°C/W
Thermal Resistance, Junction-to-Ambient	R <sub>θJA</sub>	62	68	°C/W
Soldering temperature, wave soldering only allowed at leads. (1.6mm from case for 10s)	T <sub>sold</sub>	260	260	°C

### Electrical Characteristics

T<sub>c</sub> = 25°C unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static characteristics</b>						
Drain-source breakdown voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0 V, I <sub>D</sub> =250uA	650	-	-	V
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA	2.5		4.0	V
Drain cut-off current	I <sub>DSS</sub>	V <sub>DS</sub> =650 V, V <sub>GS</sub> =0 V, T <sub>j</sub> = 25°C T <sub>j</sub> = 125°C	-	-	1	μA
Gate leakage current, Forward	I <sub>GSSF</sub>	V <sub>GS</sub> =30 V, V <sub>DS</sub> =0 V	-	-	100	nA
Gate leakage current, Reverse	I <sub>GSRR</sub>	V <sub>GS</sub> =-30 V, V <sub>DS</sub> =0 V	-	-	-100	nA
Drain-source on-state resistance	R <sub>D(on)</sub>	V <sub>GS</sub> =10 V, I <sub>D</sub> =3.5 A T <sub>j</sub> = 25°C	-	0.56	0.65	Ω
<b>Dynamic characteristics</b>						
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V, f = 1MHz	-	493	-	pF
Output capacitance	C <sub>oss</sub>		-	32	-	
Reverse transfer capacitance	C <sub>rss</sub>		-	1.6	-	
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DD</sub> = 400V, I <sub>D</sub> = 3.5A R <sub>G</sub> = 25Ω, V <sub>GS</sub> =10V	-	11.6	-	ns
Rise time	t <sub>r</sub>		-	23	-	
Turn-off delay time	t <sub>d(off)</sub>		-	53	-	
Fall time	t <sub>f</sub>		-	35.8	-	
<b>Gate charge characteristics</b>						
Gate to source charge	Q <sub>gs</sub>	V <sub>DD</sub> =520 V, I <sub>D</sub> =3.5A, V <sub>GS</sub> =0 to 10 V	-	2.8	-	nC
Gate to drain charge	Q <sub>gd</sub>		-	4.7	-	
Gate charge total	Q <sub>g</sub>		-	13.3	-	
Gate plateau voltage	V <sub>plateau</sub>		-	5.5	-	V
<b>Reverse diode characteristics</b>						
Diode forward voltage	V <sub>SD</sub>	V <sub>GS</sub> =0 V, I <sub>F</sub> =3.5A	-	0.85	-	V
Reverse recovery time	t <sub>rr</sub>	V <sub>R</sub> =50 V, I <sub>F</sub> =3.5A, dI <sub>F</sub> /dt=100 A/μs	-	201.4	-	ns
Reverse recovery charge	Q <sub>rr</sub>		-	1.3	-	μC
Peak reverse recovery current	I <sub>rrm</sub>		-	11.5	-	A

Notes:

1. Limited by maximum junction temperature, maximum duty cycle is 0.75.
2.  $I_{AS} = 2A$ ,  $V_{DD} = 50V$ , Starting  $T_j = 25^\circ C$ .

### Electrical Characteristics Diagrams

Figure 1. Output Characteristics

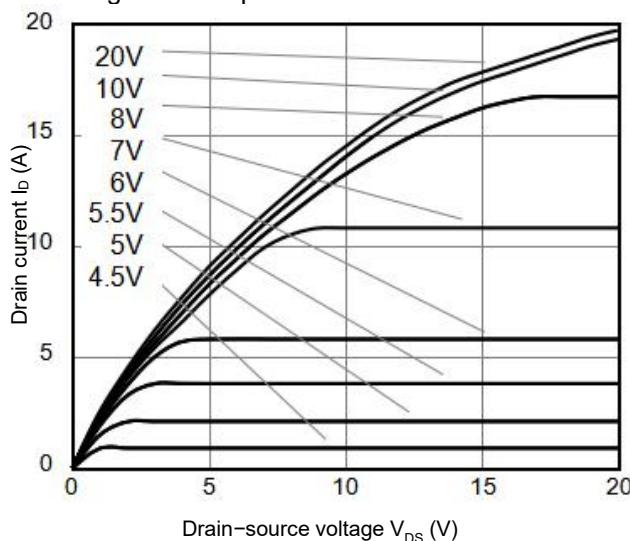


Figure 2. Transfer Characteristics

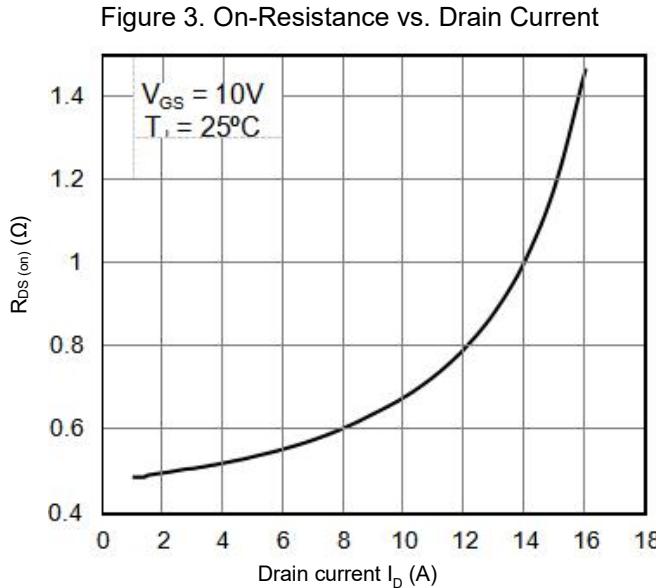
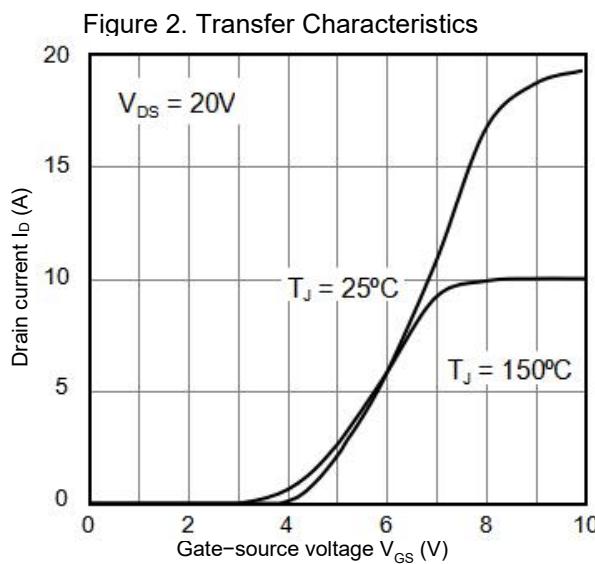


Figure 4. Capacitance Characteristics

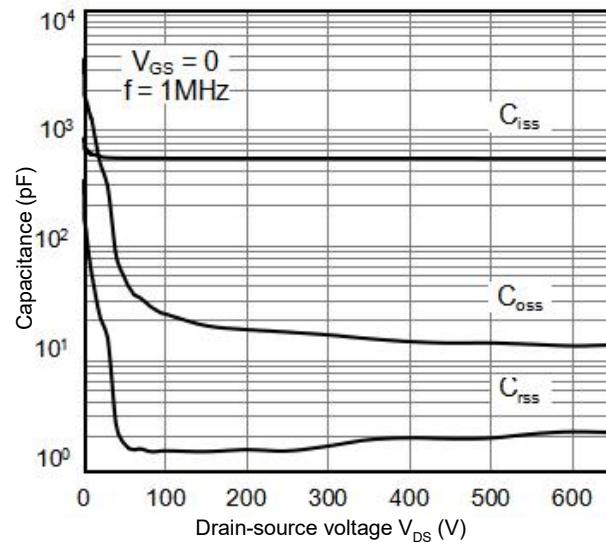


Figure 5. Gate Charge Characteristics

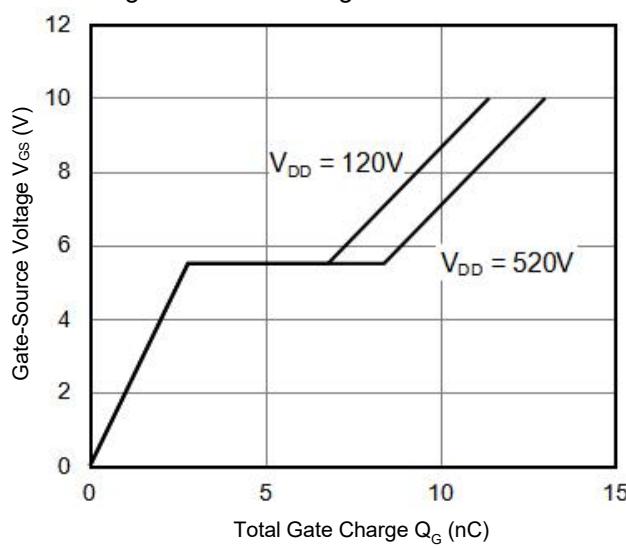


Figure 6. Body Diode Forward Voltage

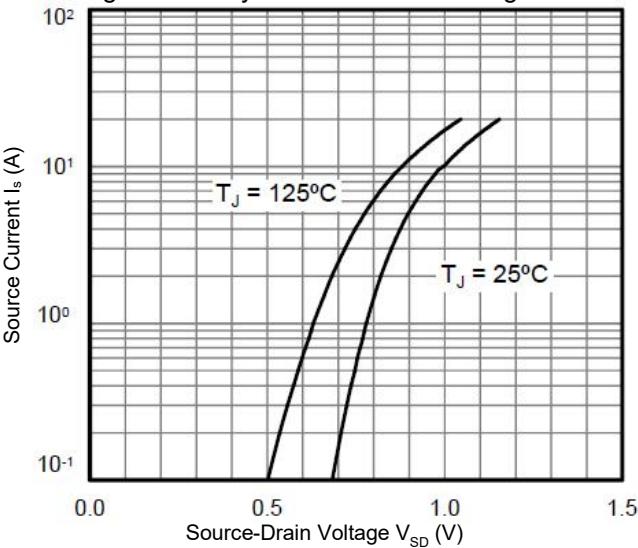


Figure 7. Breakdown Voltage vs. Temperature

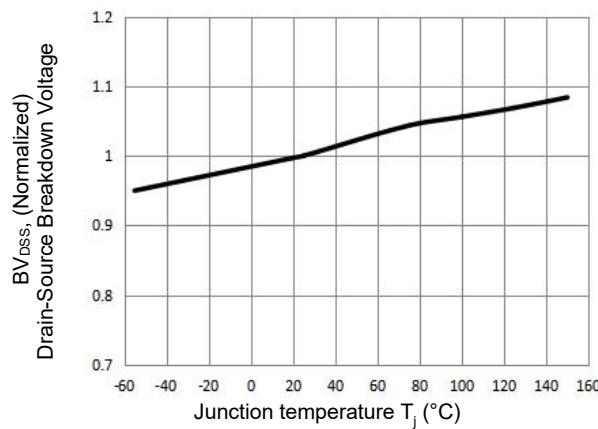


Figure 9. Maximum Safe Operating Area  
 TO-252/TO-251

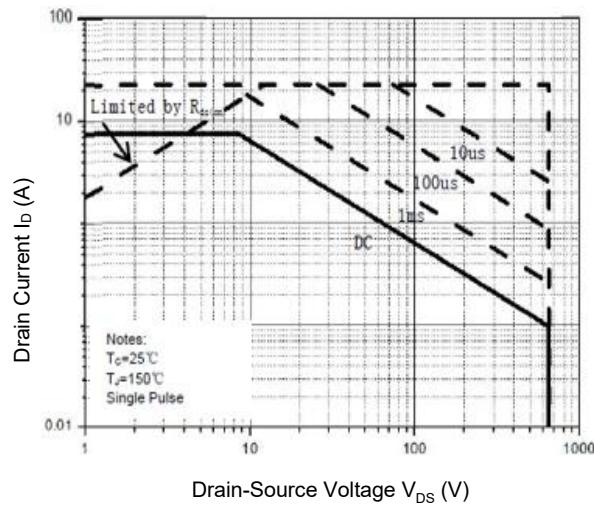


Figure 8. On-Resistance vs. Temperature

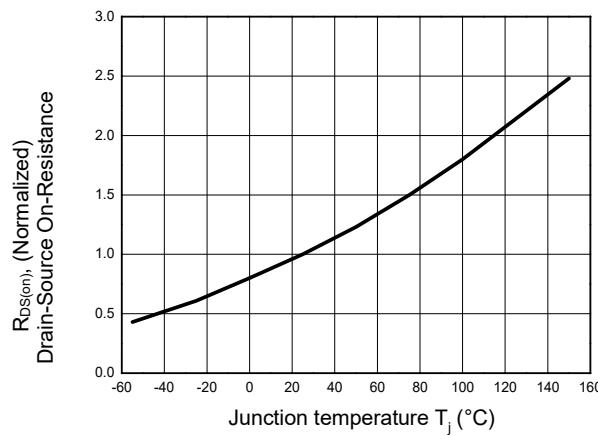
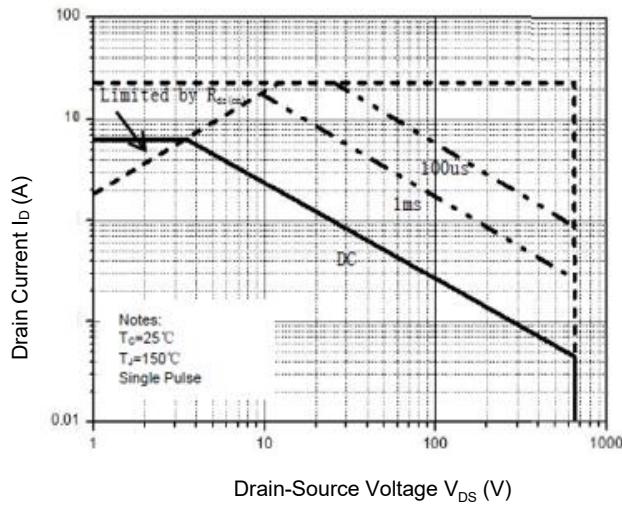
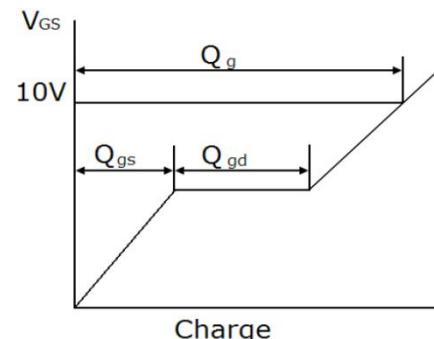
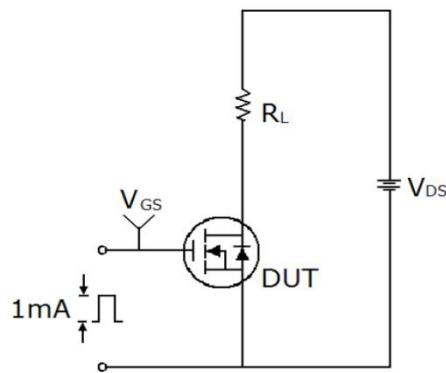


Figure 10. Maximum Safe Operating Area  
 TO-220F

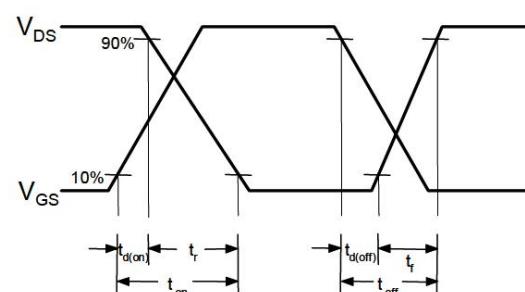
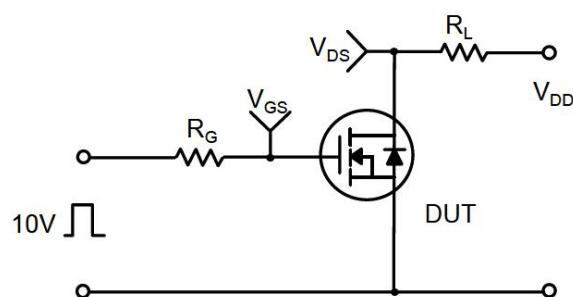


## Test Circuits

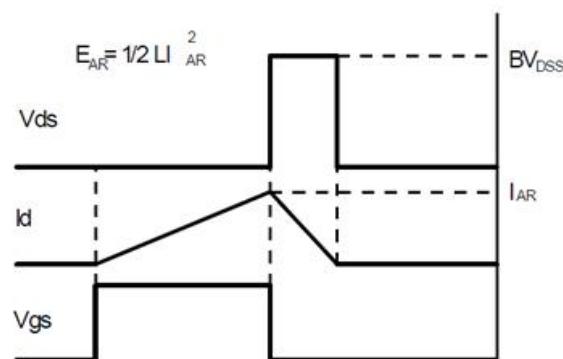
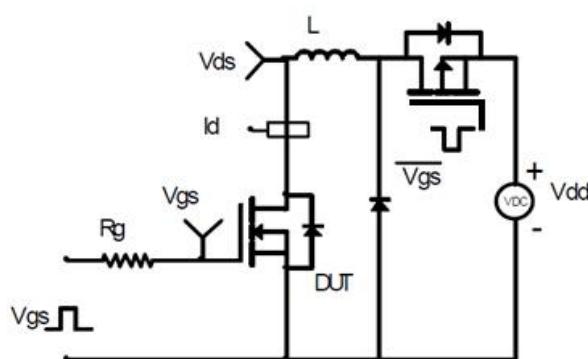
**Gate Charge Test Circuit & Waveform**



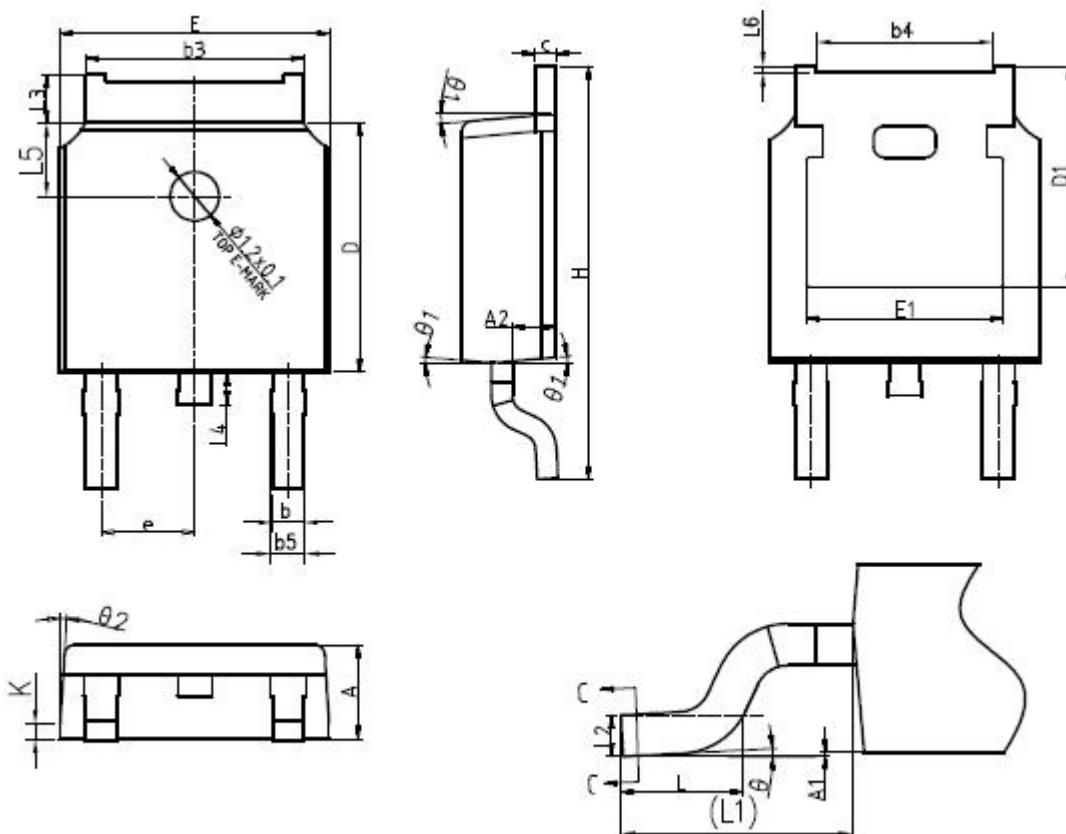
**Switching Test Circuit & Waveform**



**Unclamped Inductive Switching Test Circuit & Waveform**



Mechanical Dimensions for TO-252

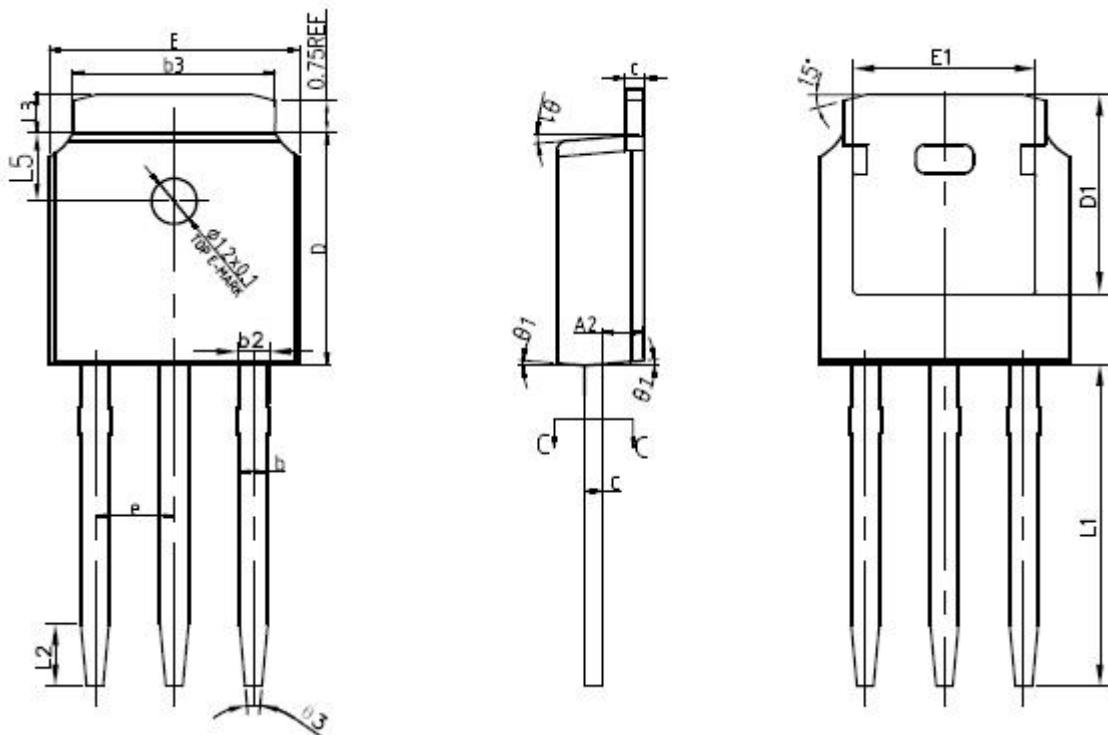


单位: mm

SYMBOL	mm		
	MIN	NOM	MAX
*A	2.20	2.30	2.38
*A1	0.00	-	0.10
A2	0.97	1.07	1.17
*b	0.72	0.78	0.85
b1	0.71	0.76	0.81
*b3	5.23	5.33	5.46
b4	4.27	4.32	4.37
b5	0.72	0.88	0.93
*c	0.47	0.53	0.58
c1	0.46	0.51	0.56
*D	6.00	6.10	6.20
D1		5.30REF	

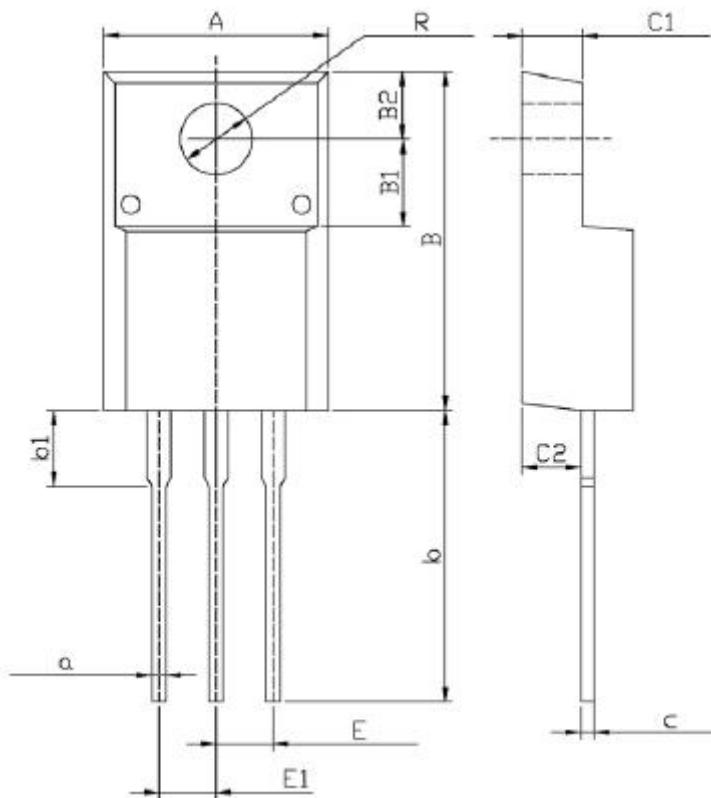
*E	6.50	6.60	6.70
E1	4.70	4.83	4.92
*e	2.286BSC		
L	1.40	1.50	1.70
L1	2.90REF		
L2	0.51BSC		
*L3	0.90	-	1.25
*L4	0.60	0.80	1.00
L5	1.70	1.80	1.90
L6	0	0.047	0.123
$\theta$	0°	-	8°
*θ1	5°	7°	9°
θ2	5°	7°	9°
K	0.40REF		

Mechanical Dimensions for TO-251



SYMBOL	MM		
	MIN	NOM	MAX
*A	2.20	2.30	2.38
*A2	0.97	1.07	1.17
*b	0.72	0.78	0.85
b1	0.71	0.76	0.81
*b2	0.72	0.88	0.95
*b3	5.23	5.33	5.46
*c	0.47	0.53	0.58
c1	0.46	0.51	0.56
*D	6.00	6.10	6.20
D1	5.30REF		
*E	6.50	6.60	6.70
E1	4.70	4.83	4.92
*e	2.286BSC		
*L1	9.20	9.40	9.60
L2	1.25	1.35	1.45
*L3	0.90	1.02	1.25
L5	1.70	1.80	1.90
*θ1	5°	7°	9°
θ2	5°	7°	9°
θ3	11°	13°	15°
K	0.40REF		

**Mechanical Dimensions for TO-220F**



Symbol	Dimensions In Millimeters		Symbol	Dimensions In Millimeters	
	Min	Max		Min	Max
C	4.3	4.7	b1	2.9	3.9
A	9.7	10.3	a	0.55	0.75
B	14.7	15.3	E	2.29	2.79
B1	3.8	4.0	E1	2.29	2.79
B2	2.9	3.1	C1	2.5	2.9
R	3.0	3.4	C2	2.5	2.7
b	12.5	13.5	c	0.5	0.7